



Product Change Notification

Change Notification #: 118397-00
Change Title: Intel® Xeon® E Processor,
PCN 118397-00, Product Support,
Transitioning from Intel Architecture to
Intel Embedded Architecture
Date of Publication: August 02, 2021

Key Characteristics of the Change:

Product Support

Forecasted Key Milestones:

Last Demand Due Date to Local Intel Representative Prior to Product Support Change:	November 05, 2021
Last Corporate Assurance Product Critical Date Prior to Product Support Change:	February 11, 2022
Last Order Date Prior to Product Support Change:	February 25, 2022
Orders are Non-Cancelable and Non-Returnable After:	February 25, 2022
Last Shipment Date Prior to Product Support Change:	August 26, 2022

Description of Change to the Customer:

No change for Intel Embedded Architecture customers.

Intel support for the products listed in the "Products Affected/Intel Ordering Codes" table below is moving to Intel Embedded Architecture for the continued support of Intel Embedded Architecture customers. The Intel Embedded Architecture terms, conditions, and pricing will go into effect for all customers after the "Last Shipment Date Prior to Product Support Change" listed above. Please contact your Intel sales representative if you have any questions regarding this change.

Customer Impact of Change and Recommended Action:

There is no expected impact to Intel Embedded Architecture customers.

For Intel Architecture customers the tray products listed on the "Products Affected/Intel Ordering Codes" table should be managed in accordance to the "Key Milestones" listed above. "Last Demand Due Date" is the date your remaining demand for these products is due to your Intel representative. These products will only remain on Intel's Corporate Assurance Process until the "Last Product Discontinuance Order Date". The "Last Corporate Assurance Product Critical Date" is the last date that customers should submit a request for product utilizing Intel's standard Corporate Assurance Criticals Process. "Orders are Non-Cancellable and Non-Returnable" date applies to both Corporate Assurance and backlog after the "Last Product Discontinuance Order" date. At this date a snapshot will be taken of all remaining backlog and/or assurance and this quantity will become non-cancellable. The "Last Product Discontinuance Order Date" is the final day for customers who carry backlog to book the Assurance Intel has granted as of the "NCNR Date". For all customers Corporate Assurance must be booked and shipped by the "Last Product Discontinuance Shipment Date". From date of PCN publication, interim booking and turn back deadlines or separate Letter Agreements will apply vs. the standard Corporate Assurance Process.

Once product support is officially transferred to Intel Embedded Architecture, all discounts approved prior to "Last Shipment Date Prior to Product Support change" will no longer be honored.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	S SPEC	MM#	Stepping
Intel® Xeon® E-2176M Processor	CL8068403359116	S R3YX	963717	U0

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 02, 2021	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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Japan Email: jcb.ijkk@intel.com

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